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November 2015

FCP125N60E

N-Channel SuperFET[®] II Easy-Drive MOSFET

600 V, 29 A, 125 m Ω

Features

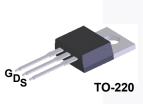
- 650 V @T_J = 150°C
- Typ. R_{DS(on)} = 102 mΩ
- Ultra Low Gate Charge (Typ. Q_g = 75 nC)
- Low Effective Output Capacitance (Typ. C_{oss(eff)} = 258 pF)
- 100% Avalanche Tested
- RoHS Compliant

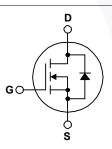
Applications

- Telecom / Sever Power Supplies
- Industrial Power Supplies

Description

SuperFET[®] II MOSFET is Fairchild Semiconductor's brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This technology is tailored to minimize conduction loss, provide superior switching performance, dv/dt rate and higher avalanche energy. Consequently, SuperFET II MOSFET easy-drive series offers slightly slower rise and fall times compared to the SuperFET II MOSFET series. Noted by the "E" part number suffix, this family helps manage EMI issues and allows for easier design implementation. For faster switching in applications where switching losses must be at an absolute minimum, please consider the SuperFET II MOSFET series.





Absolute Maximum Ratings T_C = 25°C unless otherwise noted.

Symbol		FCP125N60E	Unit			
V _{DSS}	Drain to Source Voltage		600	V		
V _{GSS}	Cata ta Sauraa Valtaga	- DC		±20	V	
	Gate to Source Voltage	- AC	(f > 1 Hz)	±30	- V	
ID	Drain Current	- Continuous (T _C = 25 ^o C)		29	A	
		- Continuous ($T_C = 100^{\circ}C$)		18		
I _{DM}	Drain Current	- Pulsed	(Note 1)	87	А	
E _{AS}	Single Pulsed Avalanche Energy (Note 2)			720	mJ	
I _{AR}	Avalanche Current (Note 1)			6	А	
E _{AR}	Repetitive Avalanche Energy (Note 1)			2.78	mJ	
dv/dt	MOSFET dv/dt	100	Maa			
	Peak Diode Recovery dv/dt (Note 3)			20	V/ns	
P _D	Devues Dissinction	(T _C = 25 ^o C) - Derate Above 25 ^o C		278	W	
	Power Dissipation			2.2	W/ºC	
T _J , T _{STG}	Operating and Storage Temperature Range			-55 to +150	°C	
TL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds			300	°C	

Thermal Characteristics

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FCP125N60E Rev. 1.0

Symbol	Parameter	FCP125N60E	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	0.45	°C/W
$R_{ hetaJA}$	Thermal Resistance, Junction to Ambient, Max.	40	°C/W

1

FCP125N60E

Part Nu			Package	Packing Method Reel Size		Tape Width		Quantity	
FCP125			TO-220	Tube	N/A		N/A	50 units	
Electrica	l Char	racteristics T _c =	25°C unless	otherwise noted.					
Symbol		Parameter		Test Condit	ions	Min.	Тур.	Max.	Unit
Off Charac	teristic	S							
	Drain to Source Breakdown Voltage			V _{GS} = 0 V, I _D = 10 mA, T _J = 25°C		600	-	-	V
BV _{DSS}			oltage	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 10 \text{ mA}, \text{ T}_{J} = 150^{\circ}\text{C}$		650	-	-	V
ΔBV _{DSS} / ΔT _J	Breakdown Voltage Temperature		ure	$I_D = 10$ mA, Referenced to $25^{\circ}C$		-	0.7	-	V/ºC
	Zara Cata Valtaga Drain Current		ant	$V_{DS} = 600 V, V_{GS} = 0 V$ $V_{DS} = 480 V, V_{GS} = 0 V, T_C = 125^{\circ}C$		-	-	1	μΑ
DSS	Zelo G	Zero Gate Voltage Drain Current				-	2	-	
I _{GSS}	Gate to	Body Leakage Currer	nt	V_{GS} = ±20 V, V_{DS} = 0	V	-	-	±100	nA
On Charac	teristic	s							
V _{GS(th)}	Gate T	hreshold Voltage		V _{GS} = V _{DS} , I _D = 250 μ	A	2.5	-	3.5	V
R _{DS(on)}	Static I	Drain to Source On Res	sistance	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 14.5 \text{ A}$		-	102	125	mΩ
9 _{FS}	Forward Transconductance			V _{DS} = 20 V, I _D = 14.5		-	25	-	S
Dynamic C	haract	eristics							
C _{iss}		apacitance				-	2250	2990	pF
C _{oss}		Capacitance		V _{DS} = 380 V, V _{GS} = 0 V, f = 1 MHz		-	60	80	pF
C _{rss}	Revers	e Transfer Capacitance	e			-	17	-	pF
C _{oss(eff.)}	Effective Output Capacitance			V_{DS} = 0 V to 480 V, V_{GS} = 0 V		-	258	-	pF
Q _{g(tot)}	Total G	ate Charge at 10V		$V_{DS} = 380 \text{ V}, \text{ I}_{D} = 14.5 \text{ A},$ $V_{GS} = 10 \text{ V}$ (Note 4)		-	75	95	nC
Q _{gs}	Gate to	Source Gate Charge				-	10	-	nC
Q _{gd}	Gate to	Drain "Miller" Charge				-	33	-	nC
ESR	Equivalent Series Resistance			f = 1 MHz		-	3.5	-	Ω
Switching	Charac	teristics							
t _{d(on)}	-	n Delay Time		$V_{DD} = 380 \text{ V}, \text{ I}_{D} = 14.5 \text{ A},$ $V_{GS} = 10 \text{ V}, \text{ R}_{g} = 4.7 \Omega$			23	56	ns
t _r	Turn-O	n Rise Time					20	50	ns
t _{d(off)}	Turn-O	ff Delay Time				-	106	222	ns
t _f	Turn-Off Fall Time			-	(Note 4)	-	23	56	ns
Drain-Sou	rce Dio	de Characteristic	S			1	1		
I _S	Maximum Continuous Drain to Source Diode Forward Current			e Forward Current		-	-	29	Α
I _{SM}	Maximum Pulsed Drain to Source Diode Fo			orward Current		-	-	87	Α
V _{SD}	Drain to Source Diode Forward Voltage		d Voltage	V _{GS} = 0 V, I _{SD} = 14.5 A		-	-	1.2	V
t _{rr}	Reverse	e Recovery Time	-	$V_{GS} = 0 V, I_{SD} = 14.5 A,$		-	376	-	ns
Q _{rr}	Reverse	everse Recovery Charge		$dI_F/dt = 100 \text{ A}/\mu\text{s}$		-	6.5	-	μC

4. Essentially independent of operating temperature.

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6

1.2

V_{DS} = 300V

64

1.5

7

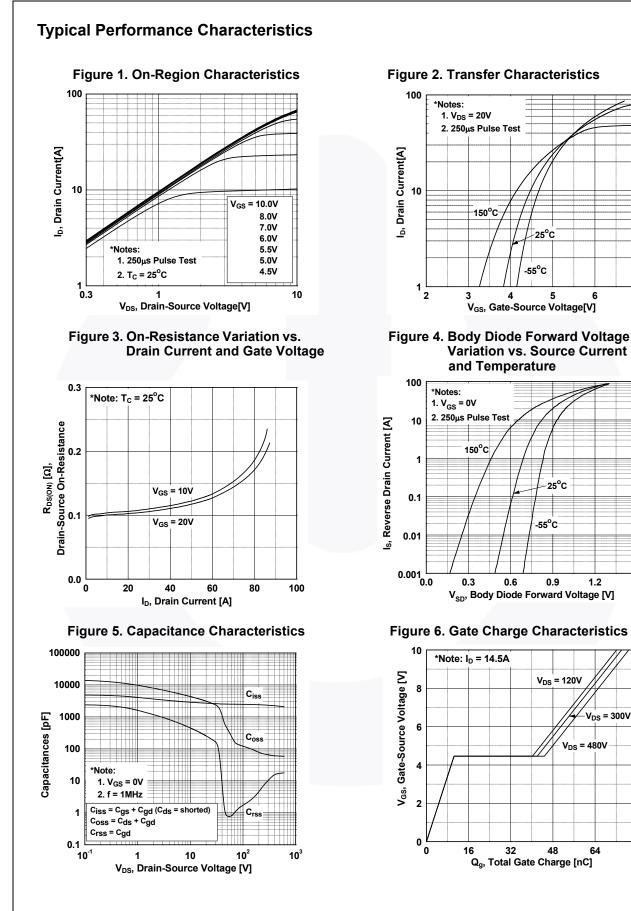
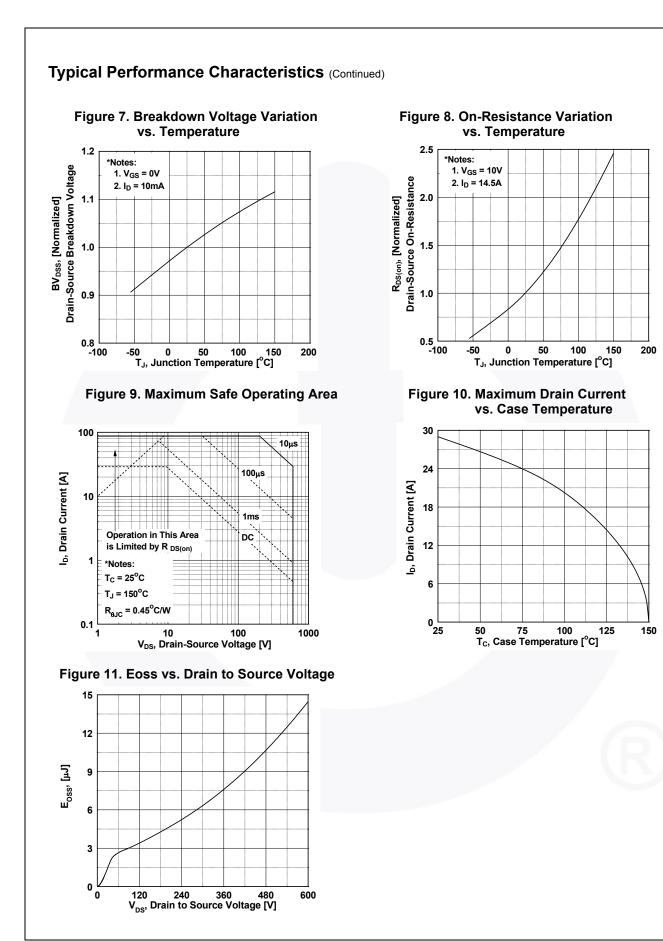


Figure 2. Transfer Characteristics

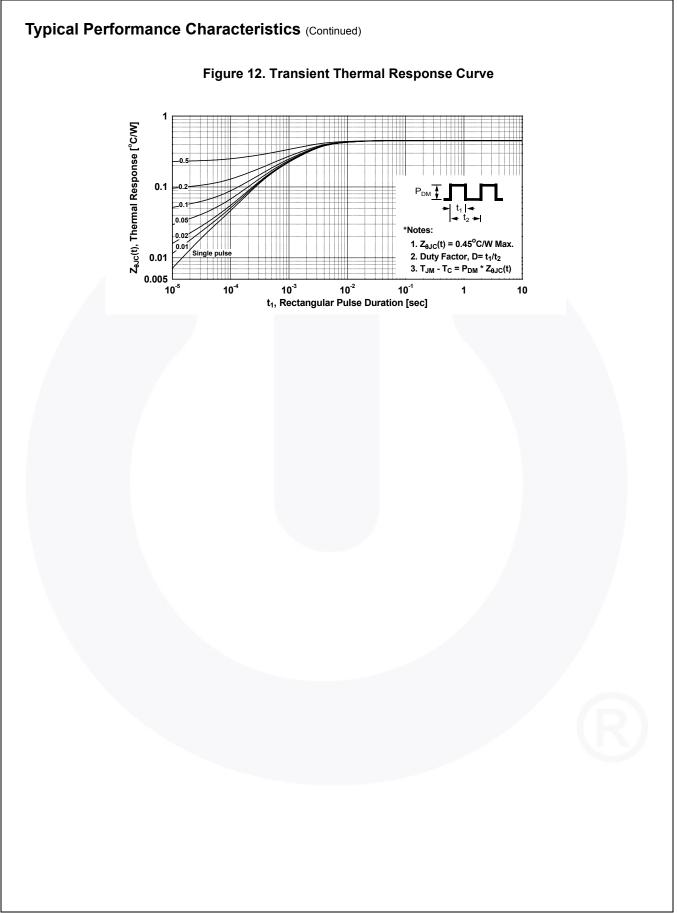
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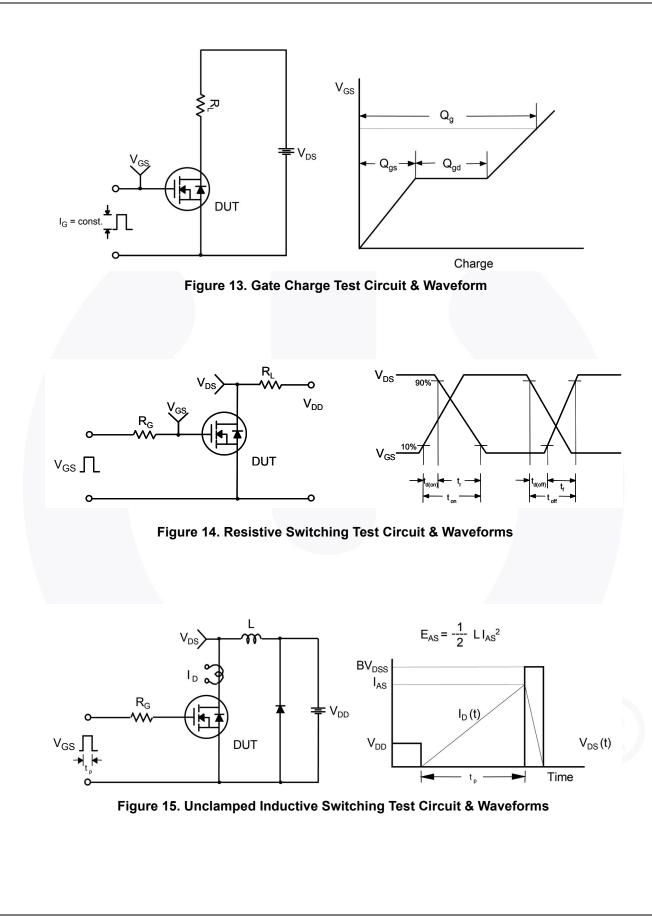
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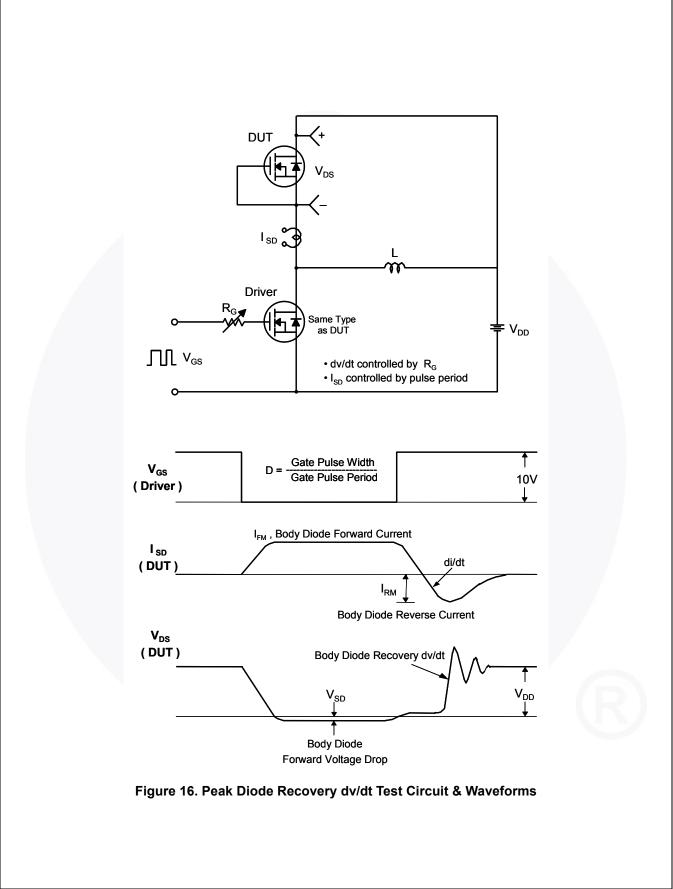
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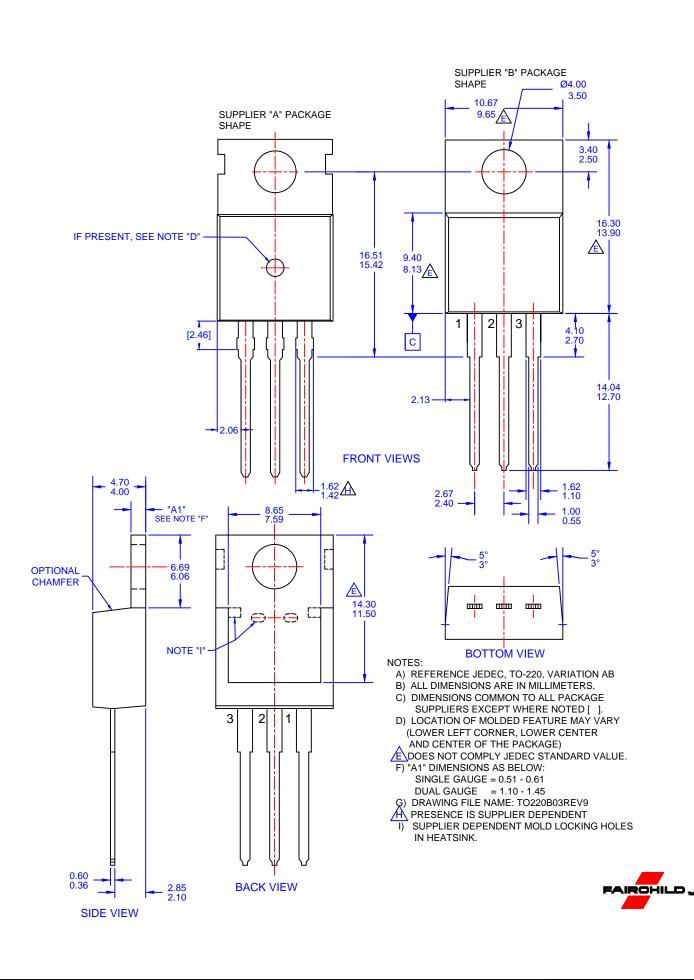


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Rev. 177